



INFORMATION DISCLOSURE STATEMENT BY APPLICANT				APPLICATION NO.: 10/021,740		ATTY. DOCKET NO.: M0925.70108US00	
				FILING DATE: October 22, 2001		CONFIRMATION NO.: 1110	
				APPLICANT: Yet-Ming Chiang et al.			
				GROUP ART UNIT: 1745		EXAMINER: J.S. Maples	
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EXAMINER:	DATE CONSIDERED:
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